

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74VHCV14FK

Hex Schmitt Inverter

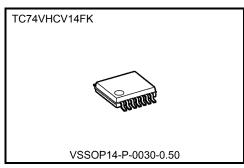
The TC74VHCV14FK is an advanced high speed CMOS SCHMITT INVERTER fabricated with silicon gate CMOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

Input pin have hysteresis between the positive-going and negative-going thresholds. Thus the TC74VHCV14FK is capable of squaring up transitions of slowly changing input signals such as line receivers.

Input protection and output circuit ensure that 0 to 5.5 V can be applied to the input and output ^(Note) pins without regard to the supply voltage. These structure prevents device destruction due to mismatched supply and input/output voltages such as battery back up, etc.

Note: VCC = 0V.



Weight VSSOP14-P-0030-0.50 : 0.02 g (typ.)

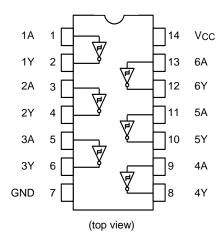
Features

- High speed: tpd = 5.0 ns (typ.) at VCC = 5 V
- Low power dissipation: ICC = 2 μA (max) at Ta = 25°C
- Wide operating voltage range: VCC (opr) = 1.8 V to 5.5 V
- Ouput current: |IOH|/IOL = 16 mA (min) (VCC = 4.5 V)
- Available in VSSOP (US)
- Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 14 type

Start of commercial production 2010-01



Pin Assignment



Truth Table

Α	Υ
L	Н
Н	L



Absolute Maximum Ratings (Note1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	Vcc	−0.5 to 7.0	V
DC input voltage	VIN	-0.5 to 7.0	V
DC output voltage	\/	-0.5 to 7.0 (Note 2)	V
	Vouт	-0.5 to V _{CC} + 0.5 (Note 3)	V
Input diode current	lıĸ	-50	mA
Output diode current	lok	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	PD	180	mW
DC Vcc/ground current	ICC/IGND	±100	mA
Storage temperature	T _{stg}	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: VCC = 0 V

Note 3: High or low state. I_{OUT} absolute maximum rating must be observed.

Note 4: VOUT < GND, VOUT > VCC

Operating Ranges (Note1)

Characteristics	Symbol	Rating	Unit	
Power supply voltage	Vcc	1.8 to 5.5	٧	
Input voltage	VIN	0 to 5.5	V	
Output voltage	Vout	0 to 5.5 (Note 2)	V	
		0 to V _{CC} (Note 3)	V	
Operating temperature	Topr	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 20 (V _{CC} = 3.3 ± 0.3 V) 0 to 1 (V _{CC} = 5 ± 0.5 V)	ms/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Note 2: VCC = 0 V

Note 3: High or low state.



Electrical Characteristics

DC Characteristics

Characteristics	Test Condition		Test Condition		Ta = 25°C			Ta = −40 to 85°C		Unit
				Vcc (V)	Min	Тур.	Max	Min	Max	
Positivo throshold voltage	Vp			1.8 2.3 3.0	_	_ _	1.65 1.85 2.20	_ _ _	1.65 1.85 2.20	. v
Positive threshold voltage	VP	_		4.5 5.5	_ _ _	_ _ _	3.15 3.85	_ _ _	3.15 3.85	
Negative threshold voltage	VN	_		1.8 2.3 3.0 4.5 5.5	0.15 0.45 0.90 1.35 1.65	 - - -	 - - -	0.15 0.45 0.90 1.35 1.65	_ _ _ _	
Hysteresis voltage	Vн		_	1.8 2.3 3.0 4.5 5.5	0.15 0.20 0.30 0.40 0.50	_ _ _ _	1.05 1.10 1.20 1.40 1.60	0.15 0.20 0.30 0.40 0.50	1.05 1.10 1.20 1.40 1.60	٧
High-level output voltage	Voh Vi	VIN = VIL	ΙΟΗ = -50 μΑ	1.8 3.0 4.5	1.7 2.9 4.4	1.8 3.0 4.5	_ _ _	1.7 2.9 4.4	_ _ _	
			$I_{OH} = -8 \text{ mA}$ $I_{OH} = -16 \text{ mA}$	3.0 4.5	2.58 3.94	_	_	2.48 3.80		
Low-level output voltage	VOL VIN =	VIN = VIH	I _{OL} = 50 μA	1.8 3.0 4.5	_ _ _	0.0 0.0 0.0	0.1 0.1 0.1	_ _ _	0.1 0.1 0.1	V
			I _{OL} = 8 mA I _{OL} = 16 mA	3.0 4.5	_ _	_ _	0.36 0.44	_ _	0.44 0.55	
Power-off leakage current	loff	VIN/VOUT = 5.5 V		0	1		0.5	-	5.0	μΑ
Input leakage current	liN	V _{IN} = 5.5 V or GND		0 to 5.5	_	_	±0.1	_	±1.0	μΑ
Quiescent supply current	Icc	VIN = VCC	VIN = VCC or GND		_	_	2.0	_	20.0	μΑ



AC Characteristics (input: tr = tf = 3 ns)

Characteristics Symbol	Test Condition			Ta = 25°C			Ta = −40 to 85°C		Unit	
		V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Min	Max	Onne	
Propagation delay tpLH time tpHL		_	2.5 ± 0.2	15	_	9.8	19.7	1.0	22.0	- ns
				50	_	12.8	24.0	1.0	27.0	
	·		3.3 ± 0.3 5.0 ± 0.5	15	_	7.0	12.8	1.0	15.0	
				50	_	9.2	16.3	1.0	18.5	
				15	_	5.0	8.6	1.0	10.0	
				50	_	6.7	10.6	1.0	12.0	
Input capacitance	C _{IN}		_		-	4	10	_	10	pF
Power dissipation capacitance	C _{PD}			(Note)	_	23	_	_	_	pF

Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

ICC (opr) = CPD·VCC·fIN + ICC/6 (per gate)

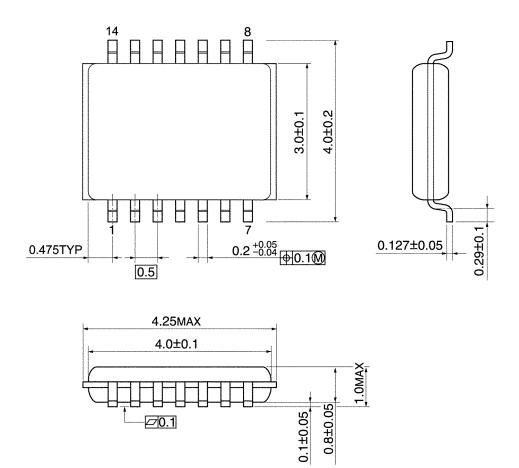
Noise Characteristics (input: $t_r = t_f = 3 \text{ ns}$)

Ch ava stavistica	Symbol	Test Condition		Ta = 25°C		l lait
Characteristics			V _{CC} (V)	Тур.	Limit	Unit
Quiet output maximum dynamic VoL	VOLP	C _L = 50 pF	3.3 5.0	0.3 0.7		V
Quiet output minimum dynamic VoL	Volv	C _L = 50 pF	3.3 5.0	-0.1 -0.2	_	V
Minimum high level dynamic input voltage	VIHD	C _L = 50 pF	5.0	-	3.5	V
Maximum low level dynamic input voltage	VILD	C _L = 50 pF	5.0	-	1.5	V



Package Dimensions

VSSOP14-P-0030-0.50 Unit: mm



Weight: 0.02 g (typ.)



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